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## Micromegas Particle Detector Nuclear Physics SBIR/STTR Exchange Meeting

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## Agenda

- Company Background
- The Need
- Agiltron Approach
- Results
- Summary

## **Agiltron At A Glance**



- Established 2001
- Over 100 employees
- \$23 million 2012 revenue
- 60,000 sq. ft. R&D, manufacturing, and administrative facilities
- ISO 9001 certified optical systems manufacturer
- Inc 500, Deloitte Fast 50 & 500, SBANE Innovation Awards





## Key Development Areas **KAGILTRON**

- Chem/Bio/Radiation Detectors
- IR Detectors and Optics
- HFI Sensors
- Photomechanical Imaging
- Nanomaterials and Devices





**PbS / PbSe IR Detectors** 







## High Energy Particle Detection AGILTRON Programs in Agiltron

#### Micromegas

- DOE SBIR Phase II
- Silicon Microfabricated Neutron Detectors
- Nano-Particle Loaded Polymer X-Ray Detector
- Low Cost Microfabricated Gamma Detectors









## The Need



Nuclear physics research need position sensitive high energy particle tracking devices

- Micromegas exhibits excellent stability, fast response, excellent spatial uniformity and energy resolution, and exceptionally high positive ion collection efficiency.
- But needs further improvements in manufacturability in large areas which can be achieved by microfabrication.



## **Agiltron's Approach**



- Design and fabricate mesh with necessary structural integrity, flatness, parallelism and spark-resistance.
- Develop and fully optimize micromegas device structures, and micro-fabrication and assembly procedures for low cost manufacturing in large areas.

Agiltron's goal is to become a leading commercial supplier of instrument-grade; and compact/low cost/high volume radiation detectors



#### **Features & Benefits**

Features	Benefits
Specially Designed Mesh Electrode	<ul> <li>Spark-resistance and long life</li> <li>Excellent structural integrity</li> <li>High energy resolution and gain</li> <li>High yield</li> </ul>
Micro-Fab Process	<ul> <li>Accurate dimensional control</li> <li>Uniform performance in large areas</li> <li>Design flexibility</li> <li>Scalable</li> <li>Low manufacturing cost</li> </ul>



#### **Micromegas via Micro-Fab Process**



There are 474 X 474 36 um diameter holes within one square inch mesh area, 54 um pitch. Pillars are *5*4 um diameter on a 312 um pitch.

# Micromegas Design Parameters



Parameters	Specifications
Mesh Gap, µm**	75
Mesh Hole Diameter, µm	36
Mesh Hole Pitch, µm	54
Mesh Material**	Ti coated Silicon
Mesh Thickness, µm**	20
Drift Gap, cm	1.5
Pillar Height, µm**	75
Pillar Diameter, µm	54
Pillar Pitch, µm	304
Pillar Material	SU-8
Anode Strip Width and Length, mm	2 by 30
Anode Strip Pitch, mm	2.2



#### **Strip Pixelated Anode**





#### Attach Leadwires to Anode Strips and Meshes





#### **Dielectric Shielding**





#### **Excellent** Linearity



# **Excellent Pixel Uniformity and** AGILTRON Extremely Low Leakage Current



- 75 μm Mesh Gap
- Pixelated Anode Strip
- P-10 gas at ambient pressure



#### **Excellent** Linearity



- 75 µm Mesh Gap
- Pixelated Anode Strip
- P-10 gas at ambient pressure

#### Alpha Radiation (NSCL) (Dr. Wolfgang Mittig)



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# **Excellent Energy Resolution**





#### **Summary**

- Designed, optimized, fabricated, assembled and tested a large area micromegas with pixelated anode.
- Achieved exceptional energy resolution of ~2% FWHM.
- Gain over 1,000 under P-10 gas at ambient pressure and at operating electric field greater than 80kV/cm.
- Excellent pixel uniformity, reproducibility, and high yield, greater than 95%.